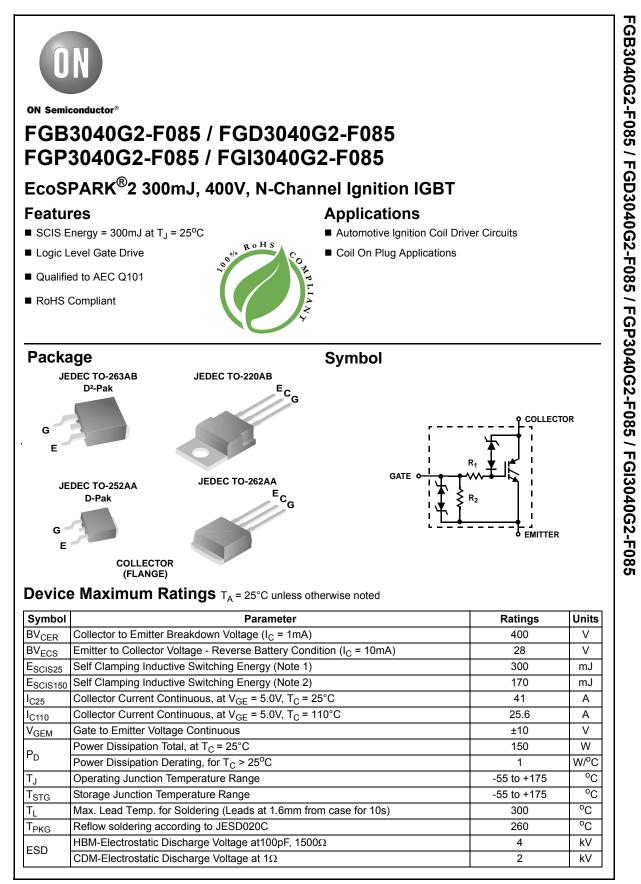
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Devic	e Marking	Device	Package F	Reel Size	Tape Widt	h	Quan	tity
FGI	B3040G2	FGB3040G2-F085	TO-263AB	330mm	24mm		80	C
FGI	D3040G2	FGD3040G2-F085	TO-252AA	330mm	16mm		250	0
FGI	P3040G2	FGP3040G2-F085	TO-220AB	Tube	N/A		50	
FGI	3040G2	FGI3040G2-F085	TO-262AA	Tube	N/A		50	
Electr	ical Char	acteristics T _A = 25°	C unless otherwise not	ed				
Symbol		Parameter	Test Cor	nditions	Min	Тур	Max	Units
3V _{CER}	Collector to E	mitter Breakdown Voltage	$T_{\rm J}$ = -40 to 150°C		370	400	430	V
BV _{CES}	Collector to E	mitter Breakdown Voltage	$I_{CE} = 10mA, V_{GE} = 0V,$ $R_{GE} = 0,$ $T_{J} = -40 \text{ to } 150^{\circ}\text{C}$			420	450	V
BV _{ECS}	Emitter to Col	lector Breakdown Voltage	I _{CE} = -20mA, V _{GE} = 0\ T _J = 25°C	Ι,	28	-	-	V
BV _{GES}	Gate to Emitte	er Breakdown Voltage	I _{GES} = ±2mA		±12	±14	-	V
I _{CER}	Collector to E	mitter Leakage Current	V _{CE} = 250V, R _{GE} = 1k	$T_J = 25^{\circ}$		-	25	μΑ
OEIX		-		$T_{\rm J} = 150^{\circ}$		-	1	mA
ECS	Emitter to Col	lector Leakage Current	V _{EC} = 24V,	$T_J = 25^{\circ}$ $T_J = 150^{\circ}$		-	1 40	mA
R ₁	Series Gate F	Resistance		1]=130	-	120	-	Ω
R ₂		er Resistance			10K	-	30K	Ω
	te Characte	eristics	L		1	1	1	1
V _{CE(SAT)}	Collector to E	mitter Saturation Voltage	$I_{CE} = 6A, V_{GE} = 4V,$	T _J = 25 ⁰	- C	1.15	1.25	V
V _{CE(SAT)}	Collector to E	mitter Saturation Voltage	I _{CE} = 10A, V _{GE} = 4.5V			1.35	1.50	V
V _{CE(SAT)}	Collector to E	mitter Saturation Voltage	$I_{CE} = 15A, V_{GE} = 4.5V,$	T _J = 150	°C -	1.68	1.85	V
E _{SCIS}	Self Clamped	Inductive Switching	L = 3.0 mHy,RG = 1KΩ VGE = 5V, (Note 1)	² , TJ = 25°	с -	-	300	mJ

Thermal Characteristics

-		
$R_{\theta JC}$	Thermal Resistance Junction to Case	
I NA IC		

Notes:

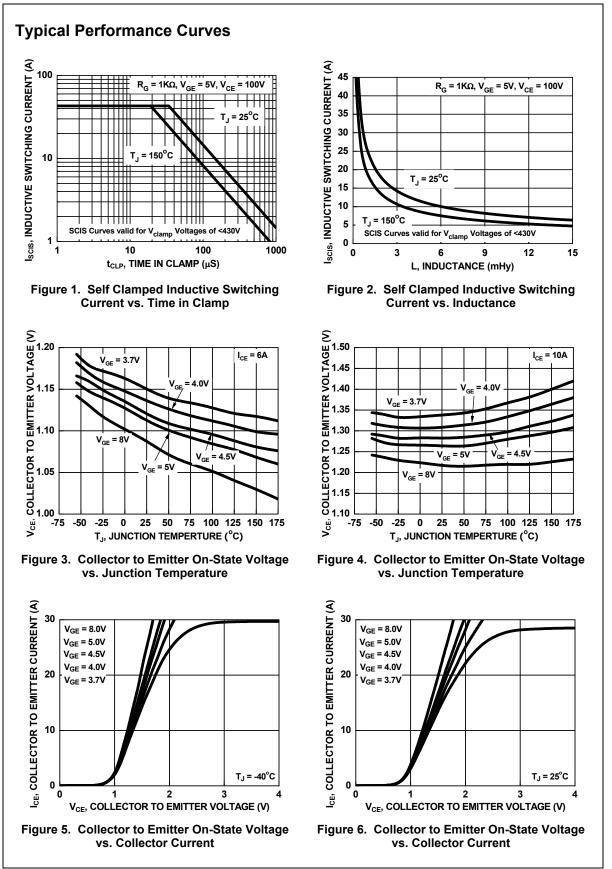
1: Self Clamping Inductive Switching Energy (E_{SCIS25}) of 300 mJ is based on the test conditions that starting Tj=25°C; L=3mHy, I_{SCIS}=14.2A,V_{CC}=100V during inductor charging and V_{CC}=0V during the time in clamp.

1

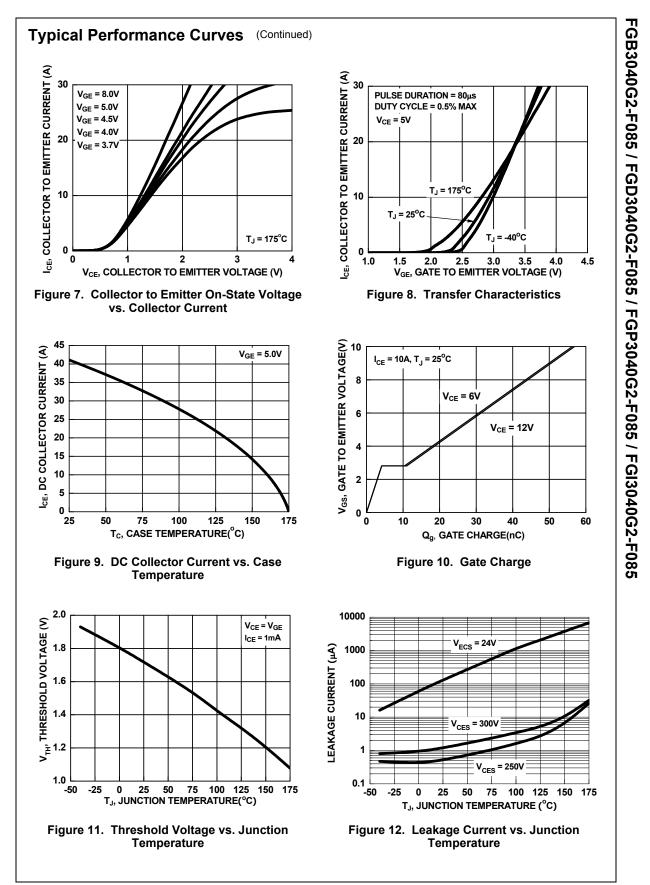
°C/W

2: Self Clamping Inductive Switching Energy ($E_{SCIS150}$) of 170 mJ is based on the test conditions that starting Tj=150°C; L=3mHy, I_{SCIS}=10.8A,V_{CC}=100V during inductor charging and V_{CC}=0V during the time in clamp.

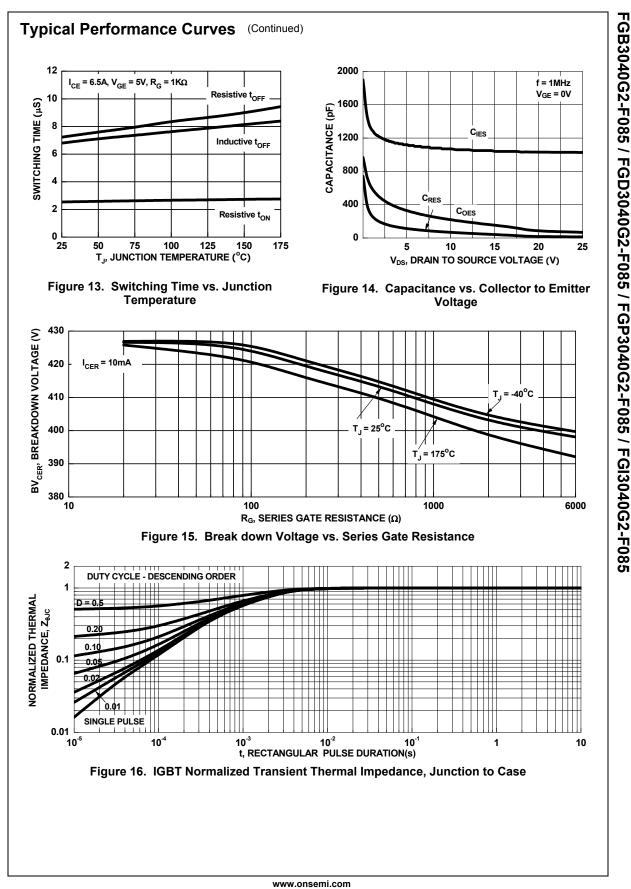
Dynamic Characteristics $Q_{G(ON)}$ Gate Charge $V_{CE} = 10A, V_{CE} = 12V, V_{CE} = 12V, V_{CE} = 5V$ $ 21$ $ nC$ $V_{GE(TH)}$ Gate to Emitter Threshold Voltage $C_E = 1mA, V_{CE} = V_{GE,}$ $T_J = 25^{\circ}C$ 1.3 1.7 2.2 V V_{GEP} Gate to Emitter Plateau Voltage $V_{CE} = 12V, I_{CE} = 10A$ $ 2.8$ $ V$ Switching Characteristics t_{QCP} Current Turn-On Delay Time-Resistive $V_{CE} = 14V, R_L = 10$ $ 0.9$ 4 μ s t_{R} Current Rise Time-Resistive $T_{IJ} = 25^{\circ}C, 1.9$ 7 μ s t_{QCFFJL} Current Turn-Off Delay Time-Inductive $V_{CE} = 300V, L = 1mH, 4.8$ 15 μ s t_{QCFFJL} Current Fail Time-Inductive $V_{CE} = 5V, R_G = 1K\Omega$ $ 2.0$ 15 μ s	Symbol	Parameter	Test Condi	tions	Min	Тур	Max	Units
$\begin{array}{c c c c c c c c c c c c c c c c c c c $	Dynam	ic Characteristics						
$\begin{array}{c c c c c c c c c c c c c c c c c c c $	Q _{G(ON)}	Gate Charge			-	21	-	nC
V_{GEP} Gate to Emitter Plateau Voltage $V_{CE} = 12V$, $I_{CE} = 10A$ -2.8-VSwitching Characteristics $t_{d(ON)R}$ Current Turn-On Delay Time-Resistive $V_{CE} = 14V$, $R_L = 1\Omega$ -0.94 μs t_{rR} Current Rise Time-Resistive $V_{GE} = 5V$, $R_G = 1K\Omega$ -1.97 μs $t_{d(OFF)L}$ Current Turn-Off Delay Time-Inductive $V_{CE} = 300V$, $L = 1mH$,-4.815 μs $V_{GE} = 5V$, $R_G = 1K\Omega$ -0.94 μs	V _{GE(TH)}	Gate to Emitter Threshold Voltage	I_{CE} = 1mA, V_{CE} = V_{GE}					V
$\begin{array}{c c c c c c c c c c c c c c c c c c c $	V _{GEP}	Gate to Emitter Plateau Voltage	V _{CE} = 12V, I _{CE} = 10A		-	2.8	-	V
$\begin{array}{c c} V_{GE} = 5V, \ R_G = 1K\Omega \\ T_J = 25^{\circ}C, \end{array} \qquad \begin{array}{c c} - & 1.9 & 7 & \mu s \\ \hline t_{d(OFF)L} & Current Turn-Off Delay Time-Inductive \\ V_{CE} = 300V, \ L = 1mH, \\ V_{GE} = 5V, \ R_G = 1K\Omega \end{array}$	Switch	ing Characteristics						
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	t _{d(ON)R}	Current Turn-On Delay Time-Resistive			-	0.9	4	μS
t _{d(OFF)L} Current Turn-Off Delay Time-Inductive $V_{CE} = 300V$, L = 1mH, V _{GE} = 5V, R _G = 1KΩ	t _{rR}	Current Rise Time-Resistive			-	1.9	7	μS
t_{fL} Current Fall Time-Inductive $V_{GE} = 5V, R_G = 1K\Omega$ $I_{CE} = 6.5A, T_J = 25^{\circ}C,$ - 2.0 15 µs	t _{d(OFF)L}	Current Turn-Off Delay Time-Inductive	V _{CE} = 300V, L = 1mH,		-	4.8	15	μS
	ta		11/ - 51/ P - 1kO					•
	ΥL	Current Fall Time-Inductive	$V_{GE} = 5V$, $K_G = 1K_2$ $I_{CE} = 6.5A$, $T_J = 25^{\circ}C$,		-	2.0	15	-

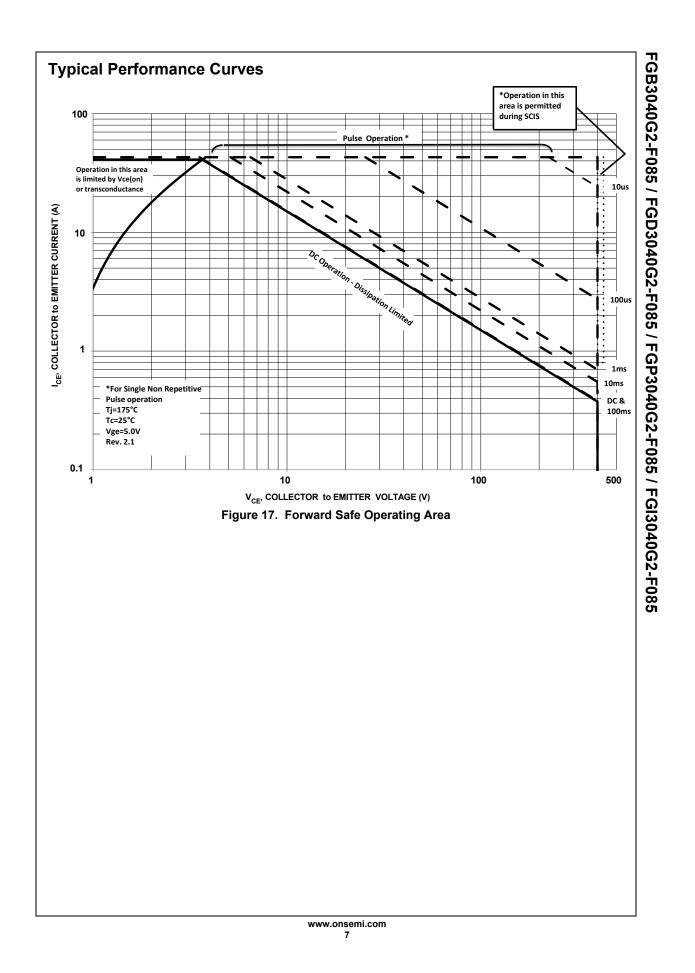


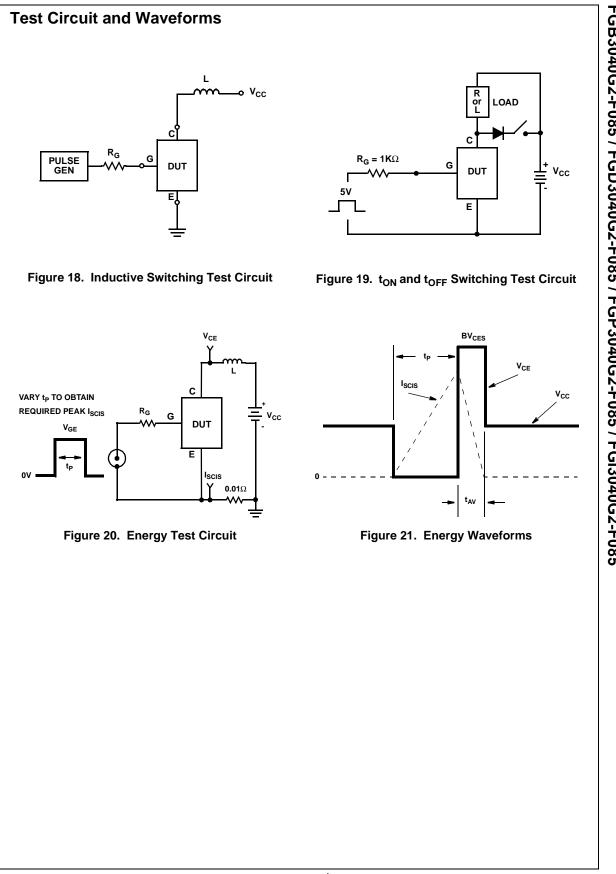
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